

Electronics

Across 3 Steps of Industry Chain

Design Verification and Simulation



● Computer Aided Engineering (CAE)

- Mold Flow Simulation
- Heat and Fluid Simulation
- Mechanical Analysis
- Dynamic Structural Analysis
- Structural, Dynamic and Motion
- Robotic Simulation
- Customized Machine Simulation
- Production Line Simulation
- Product Structure Optimisation

● Multiphysics Simulation

- Electromagnetic Characteristics of RF Devices Analysis
- Electromagnetic Field, Electromagnetic Compatibility Simulation
- Fluid Flow Analysis
- Temperature Field and Heat Flux Analysis
- Product Design Optimisation

3D Prototyping and Small Batch Manufacturing



- Conformal Cooling Tool Design & Production
- 3D Printing, 3D Scanning, 3D Modelling
- Powder Injection Moulding (Metal & Ceramic)

Product Testing



- Products, Machinery and Tools Failure Analysis



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